

微纳技术著作丛书（影印版）

纳米力学与材料： 理论、多尺度方法 and 应用

Nano Mechanics and Materials

Liu Wing Kam
Karpov Eduard G.
Park Harold S.



科学出版社

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- Analysis of mechanical, biological, self-healing and nano/bio composite materials and systems.
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内 容 简 介

合成与分析纳米物质特性的能力取得了革命性的进展,广泛应用于生物医学、机械、电子、精密材料以及军事工程等领域。纳米力学是研究和描述单个原子、系统和结构在各种载荷条件下响应的机械行为特性的学科,它的发展促进了该技术的进步。尤其是多尺度建模方法,它可以使此领域的工程师更好的理解微纳米材料。

本书由该领域内资深专家撰写,对纳米力学和材料的基本概念进行了介绍,侧重于多重尺度建模方法和技术的研究。本书内容包括:分子力学基础,微粒系统、晶格机械及现代多尺度建模理论等。

本书是一本相关领域电子工程师、材料科研工作者开发微纳米材料应用的全面的指南,同时也可作为微纳米力学和微纳米技术专业研究生的参考书。

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序

科学出版社准备出版一套《微纳技术著作丛书》，包括原创作品和引进作品（影印或翻译）两种形式，并聘请专家组成编委会。这是一件大事，希望能坚持把它办好。

微纳米技术作为 21 世纪重要的一项技术，已成为国际科学界和工程技术界研究的热点。近年来，微米纳米技术进展迅速，已经发展成为一个包含机械、材料、电子、光学、化学、生物、基因工程、医学等基础学科的综合领域，而不仅仅属于任何单一的科学与技术门类。就其产品而言，也早已超越了人们广为熟悉的微型加速度传感器和纳米碳管等，呈现出向各个科学和技术领域全面渗透的趋势。

由于微纳米技术使得人们除了可以在同一基片上实现包括机械、流体、化学、生物、光学等器件外，也可以将信号处理和传输系统集成在同一基片上用以处理信息，决定计划，控制周围环境，从而大大提高最终产品的综合性能，实现高度智能化。在未来的航空航天、生物医学、环境监控、无线通信、汽车和交通、石油化工、能源、工农业、国家安全、食品和消费的各个领域都将有广泛应用，对国民经济、科学技术、社会发展与国家安全具有重要意义。今后的几十年里，随着微米纳米技术的迅速发展和向现代科学和技术的各个门类渗透，其对我们现代生活的各个方面带来的影响将是长期和深远的。从某种意义上来说，微米纳米技术的发展，可能改变人类的工作和生活方式，乃至基本概念，其潜在的影响有可能和以计算机技术为代表的微电子工业对世界的影响相提并论。

正是由于其诱人的应用前景和巨大的潜在市场，微米纳米技术目前已成为世界各国大力投资进行研究和发展的热点领域，其研究范围包括了材料、器件和系统，涉及的技术包含机理研究、设计分析、计算仿真、制造工艺、系统集成或组装、测控技术和应用研究等。随着微纳米技术的迅猛发展，近年来国外有大量这方面的专业书籍出版。

《微纳技术著作丛书》涵盖材料开发、系统设计、检测技术、集成技术、通信网络、传感系统、微加工技术等方面，它们都是本领域的研究热点。这套丛书的出版对促进我国微米纳米技术的发展将有很大的推动作用。

这套丛书中，原创作品收录的都是国内从事微纳技术的一线研究人员在本领域的研究成果与心得，具有很强的独立性、创造性和系统性。引进作品都是与国际知名的出版集团合作，经国内专家的甄别，挑选出能反映国外最新研究成果、对国内读者又有借鉴价值的作品，具有权威性、前瞻性和可读性。因为微纳米技

术是一个交叉学科领域，我们有意识的选择了一些由多人合写的专著。通常这类著作都是由相关领域的知名专家，各自在每一章节涵盖一个专题，既有进行综合性的论述，也有个人的具体独创性研究。这样的书籍，通常能帮助读者既获得某一领域的研究概况，又能从一个具体的应用专题中获得收益。

2007年初推出的第一批影印版图书，我和王万军教授进行了评读，此套丛书很实用，不少作者在该领域有很高的声望。我们建议致力于微米纳米技术的研究人员，包括研究生、技术人员，能够花些时间阅读。

总之，我们对科学出版社组织出版这套丛书的举措很赞赏，也希望他们能将这一工作认真、长期地做下去。同时，我们也希望国内的专家能够积极、踊跃地加盟，为我国微米纳米技术的推进做出贡献。

周兆英 王万军

2006年12月7日

Contents

1	Introduction	1
1.1	Potential of Nanoscale Engineering	1
1.2	Motivation for Multiple Scale Modeling	2
1.3	Educational Approach	5
2	Classical Molecular Dynamics	7
2.1	Mechanics of a System of Particles	7
2.1.1	Generalized Coordinates	8
2.1.2	Mechanical Forces and Potential Energy	8
2.1.3	Lagrange Equations of Motion	10
2.1.4	Integrals of Motion and Symmetric Fields	12
2.1.5	Newtonian Equations	13
2.1.6	Examples	14
2.2	Molecular Forces	17
2.2.1	External Fields	18
2.2.2	Pair-Wise Interaction	20
2.2.3	Multibody Interaction	24
2.2.4	Exercises	26
2.3	Molecular Dynamics Applications	28
3	Lattice Mechanics	37
3.1	Elements of Lattice Symmetries	37
3.1.1	Bravais Lattices	38
3.1.2	Basic Symmetry Principles	40
3.1.3	Crystallographic Directions and Planes	42
3.2	Equation of Motion of a Regular Lattice	42
3.2.1	Unit Cell and the Associate Substructure	43
3.2.2	Lattice Lagrangian and Equations of Motion	45
3.2.3	Examples	47
3.3	Transforms	49
3.3.1	Fourier Transform	50
3.3.2	Laplace Transform	51
3.3.3	Discrete Fourier Transform	53

3.4	Standing Waves in Lattices	54
3.4.1	Normal Modes and Dispersion Branches	55
3.4.2	Examples	57
3.5	Green's Function Methods	58
3.5.1	Solution for a Unit Pulse	59
3.5.2	Free Lattice with Initial Perturbations	61
3.5.3	Solution for Arbitrary Dynamic Loads	61
3.5.4	General Inhomogeneous Solution	62
3.5.5	Boundary Value Problems and the Time History Kernel	62
3.5.6	Examples	65
3.6	Quasi-Static Approximation	66
3.6.1	Equilibrium State Equation	66
3.6.2	Quasi-Static Green's Function	67
3.6.3	Multiscale Boundary Conditions	67
4	Methods of Thermodynamics and Statistical Mechanics	79
4.1	Basic Results of the Thermodynamic Method	80
4.1.1	State Equations	81
4.1.2	Energy Conservation Principle	84
4.1.3	Entropy and the Second Law of Thermodynamics	86
4.1.4	Nernst's Postulate	88
4.1.5	Thermodynamic Potentials	89
4.2	Statistics of Multiparticle Systems in Thermodynamic Equilibrium	91
4.2.1	Hamiltonian Formulation	92
4.2.2	Statistical Description of Multiparticle Systems	93
4.2.3	Microcanonical Ensemble	97
4.2.4	Canonical Ensemble	101
4.2.5	Maxwell-Boltzmann Distribution	104
4.2.6	Thermal Properties of Periodic Lattices	107
4.3	Numerical Heat Bath Techniques	111
4.3.1	Berendsen Thermostat	112
4.3.2	Nosé-Hoover Heat Bath	118
4.3.3	Phonon Method for Solid-Solid Interfaces	119
5	Introduction to Multiple Scale Modeling	123
5.1	MAAD	124
5.2	Coarse-Grained Molecular Dynamics	126
5.3	Quasi-Continuum Method	126
5.4	CADD	128
5.5	Bridging Domain	129
6	Introduction to Bridging Scale	131
6.1	Bridging Scale Fundamentals	131
6.1.1	Multiscale Equations of Motion	133
6.2	Removing Fine Scale Degrees of Freedom in Coarse Scale Region	136
6.2.1	Relationship of Lattice Mechanics to Finite Elements	137
6.2.2	Linearized MD Equation of Motion	139

6.2.3	Elimination of Fine Scale Degrees of Freedom	141
6.2.4	Commentary on Reduced Multiscale Formulation	143
6.2.5	Elimination of Fine Scale Degrees of Freedom: 3D Generalization	143
6.2.6	Numerical Implementation of Impedance Force	150
6.2.7	Numerical Implementation of Coupling Force	151
6.3	Discussion on the Damping Kernel Technique	152
6.3.1	Programming Algorithm for Time History Kernel	157
6.4	Cauchy–Born Rule	158
6.5	Virtual Atom Cluster Method	159
6.5.1	Motivations and General Formulation	159
6.5.2	General Idea of the VAC Model	163
6.5.3	Three-Way Concurrent Coupling with QM Method	164
6.5.4	Tight-Binding Method for Carbon Systems	167
6.5.5	Coupling with the VAC Model	169
6.6	Staggered Time Integration Algorithm	170
6.6.1	MD Update	170
6.6.2	FE Update	172
6.7	Summary of Bridging Scale Equations	172
6.8	Discussion on the Bridging Scale Method	173
7	Bridging Scale Numerical Examples	175
7.1	Comments on Time History Kernel	175
7.2	1D Bridging Scale Numerical Examples	176
7.2.1	Lennard-Jones Numerical Examples	176
7.2.2	Comparison of VAC Method and Cauchy–Born Rule	178
7.2.3	Truncation of Time History Kernel	179
7.3	2D/3D Bridging Scale Numerical Examples	182
7.4	Two-Dimensional Wave Propagation	184
7.5	Dynamic Crack Propagation in Two Dimensions	187
7.6	Dynamic Crack Propagation in Three Dimensions	195
7.7	Virtual Atom Cluster Numerical Examples	200
7.7.1	Bending of Carbon Nanotubes	200
7.7.2	VAC Coupling with Tight Binding	200
8	Non-Nearest Neighbor MD Boundary Condition	203
8.1	Introduction	203
8.2	Theoretical Formulation in 3D	203
8.2.1	Force Boundary Condition: 1D Illustration	207
8.2.2	Displacement Boundary Condition: 1D Illustration	210
8.2.3	Comparison to Nearest Neighbors Formulation	211
8.2.4	Advantages of Displacement Formulation	212
8.3	Numerical Examples: 1D Wave Propagation	212
8.4	Time-History Kernels for FCC Gold	213
8.5	Conclusion for the Bridging Scale Method	215
8.5.1	Bridging Scale Perspectives	220

9 Multiscale Methods for Material Design	223
9.1 Multiresolution Continuum Analysis	225
9.1.1 Generalized Stress and Deformation Measures	227
9.1.2 Interaction between Scales	231
9.1.3 Multiscale Materials Modeling	232
9.2 Multiscale Constitutive Modeling of Steels	234
9.2.1 Methodology and Approach	235
9.2.2 First-Principles Calculation	235
9.2.3 Hierarchical Unit Cell and Constitutive Model	237
9.2.4 Laboratory Specimen Scale: Simulation and Results	239
9.3 Bio-Inspired Materials	244
9.3.1 Mechanisms of Self-Healing in Materials	244
9.3.2 Shape-Memory Composites	246
9.3.3 Multiscale Continuum Modeling of SMA Composites	250
9.3.4 Issues of Modeling and Simulation	256
9.4 Summary and Future Research Directions	260
10 Bio–Nano Interface	263
10.1 Introduction	263
10.2 Immersed Finite Element Method	265
10.2.1 Formulation	265
10.2.2 Computational Algorithm of IFEM	268
10.3 Vascular Flow and Blood Rheology	269
10.3.1 Heart Model	269
10.3.2 Flexible Valve–Viscous Fluid Interaction	270
10.3.3 Angioplasty Stent	270
10.3.4 Monocyte Deposition	272
10.3.5 Platelet Adhesion and Blood Clotting	272
10.3.6 RBC Aggregation and Interaction	274
10.4 Electrohydrodynamic Coupling	280
10.4.1 Maxwell Equations	281
10.4.2 Electro-manipulation	283
10.4.3 Rotation of CNTs Induced by Electroosmotic Flow	285
10.5 CNT/DNA Assembly Simulation	287
10.6 Cell Migration and Cell–Substrate Adhesion	290
10.7 Conclusions	295
Appendix A Kernel Matrices for EAM Potential	297
Bibliography	301
Index	315

Introduction

Over the past three decades, we have acquired new tools and techniques to synthesize nanoscale objects and learn their many incredible properties. The high-resolution electron microscopes that are available today enable the visualization of single atoms; furthermore, the manipulation of these individual atoms is possible using scanning probe techniques. Synthesis of advanced materials provides the technology to tailor-design systems from as small as molecules to as large as the fuselage of a plane. We now have the technology to 本身 detect single molecules, bacteria or virus particles. We can make protective coatings more wear-resistant than diamond and fabricate alloys and composites such that they are stronger than ever before. Advances in the synthesis of nanoscale materials have stimulated ever-broader research activities in science and engineering devoted entirely to these materials and their applications. This is due in large part to the combination of their expected structural perfection, small size, low density, high stiffness, high strength and excellent electronic properties. As a result, nanoscale materials may find use in a wide range of applications in material reinforcement, field emission panel display, chemical sensing, drug delivery, nanoelectronics and tailor-designed materials. Nanoscale devices have a great potential as sensors and medical diagnostic and delivery systems.

With the confluence of interest in nanotechnology, the availability of experimental tools to synthesize and characterize systems at the nanometer scale, and computational tools widely accessible to model microscale systems by coupled continuum/molecular/quantum mechanics, we are poised to unravel the traditional gap between the atomic and the macroscopic world of mechanics and materials. This in turn opens up new opportunities in 教育 education and research.

1.1 Potential of Nanoscale Engineering

Nanotechnology is making, and will continue to make, an impact in key areas for societal improvement. In particular, it has been found that basic mechanics principles have found many applications in nanoscience and nanoengineering. For example, current research

efforts deal with the application of cell mechanics to neurobiology and cancer research. Currently, a key limitation is in understanding the behavior of the myriad of different cellular structures, interactions and adhesive forces. Once this is established, these mechanisms can be used to develop treatment strategies for cancer, for example, in the prevention of metastasis.

The design and production of materials from the atomic scale up is a goal that is becoming increasingly realizable by the application of DNA to nanotechnology and biotechnology. Owing to the predictable manner in which DNA strands interact, research is now being performed to design solid materials by manipulating individual DNA strands as the basic building blocks. Use of DNA will lead to new materials with novel mechanical, chemical and optical properties, controllable at the unit of the basic building block.

Nanotechnology also has the potential to greatly improve our resistance to terrorism and improve our national security by improving the technologies available to our armed forces. Nanoscale sensors are being developed for the purpose of detecting illegal and harmful airborne chemicals. Our soldiers will benefit from new, energy-absorbing polymer-based nanomaterials that will provide ballistic protection while being light enough to allow maximum mobility. Research along these crucial lines is being done, for example, at the MIT Institute for Soldier Nanotechnologies.

Protective coatings is another area that has greatly benefited from nanotechnology. These coatings have a wide range of applicability, examples being gears and bearings in the automotive industry, and naval vessels for the military. In all these applications, the goal has been to replace or augment previously known super hard materials such as diamond in designing tribological parts that use nanoceramic-type coatings to reduce friction and wear. Extending the lifetime of these parts is crucial, and will lead to a massive reduction in maintenance costs for these components.

Another key area in nanotechnology is in electronics, microelectromechanical systems (MEMS) and nanoelectromechanical systems (NEMS). For example, the storage capacity of computer hard drives has been increased by orders of magnitude, thanks to magnetic materials whose thickness is on the order of nanometers. Medicine is another key area in which NEMS and MEMS devices have made, and will make, large contributions. Here, nanotechnology can be used to dynamically image living biological systems, such that the real-time study of bacteria and diseases can be performed.

1.2 Motivation for Multiple Scale Modeling

Current research in engineering is just beginning to impact molecular scale mechanics and materials and would benefit from interaction with the basic sciences. For solids, research in the area of plasticity and damage has experienced some success in advancing microscale component design. The development of carbon nanotubes is also an area in which nanoscale research has clearly played a major role. For fluids, coupling physics phenomena at the nanoscale is crucial in designing components at the microscale. Electrophoresis and electroosmotic flows coupled with particulate motion in a liquid have been important research areas that have had great impact in the homeland security area. Microfluidic devices often comprise components that couple chemistry, and even electrochemistry, with fluid motion. Once the physics-based models are determined for the solids and fluids,

computational approaches will need to be employed or developed to capture the coupled physics phenomena.

While microscale and nanoscale systems and processes are becoming more viable for engineering applications, our knowledge of their behavior and our ability to model their performance remains limited. Continuum-based computational capabilities are obviously not applicable over the full range of operational conditions of these devices. Noncontinuum behavior is observed in large deformation behavior of nanotubes, ion deposition processes, gas dynamic transport, and material mechanics as characteristic scales drop toward the micron scale. At the scales of nanodevices, interactions between thermal effects and mechanical response can become increasingly important. 能生存

Furthermore, nanoscale components will be used in conjunction with components that are larger and respond at different timescales. In such hybrid systems, the interaction of different time and length scales may play a crucial role in the performance of the complete system. Single scale methods such as *ab initio* methods or molecular dynamics (MD) would have difficulty in analyzing such hybrid structures owing to the large range of timescales and length scales. For the design and study of nanoscale materials and devices in microscale systems, models must span length scales from nanometers to hundreds of microns.

Computational power has doubled approximately every 18 months, in accordance with Moore's law. Despite this fact and the fact that desktop computers can now routinely simulate million atom systems, simulations of realistic atomic system require at least tens of billions of atoms. In short, such systems cannot be modeled by continuum methods, because they are too small, nor can they be modeled by molecular methods because they are too large. Hence, coupled multiscale methods are urgently needed for this class of problems.

Multiple scale methods generally imply the utilization of information at one length scale to subsequently model the response of the material at larger length scales. These methods can be divided into two categories: hierarchical and concurrent. Hierarchical multiple scale methods directly utilize the information at a small length scale as an input into a larger model via some type of averaging process. The Young's modulus is a good example of this; the structural material stiffness is found as a single quantity, through homogenization of all defects and microstructure at the micro- and nanoscales. Concurrent multiple scale methods are those that run simultaneously; in these methods, the information at the smaller length scale is calculated and inputted into the larger scale model on the fly. In this book, we shall concentrate on the development of concurrent multiple scale methods, much of which has occurred within the past decade. We note in particular the work of Li and Liu (2004), as well as two excellent review papers that comprehensively cover the field, namely, those of Liu et al. (2004c) and Curtin and Miller (2003).

Multiscale simulation methods will be a valuable tool in design; just as computer-aided engineering (CAE) on the microscale was facilitated by finite element methods. We envision that the availability of tools for multiscale analysis will provide a powerful impetus to the development of new nanodevices. More specifically, we believe that the next generation of CAE software will integrate nano and microstructures into the fundamental CAE capabilities for design and manufacturing. To move toward this goal, the development and validation of predictive multiscale simulation models that integrate materials design into virtual manufacturing processes is imperative. These multiscale models must incorporate

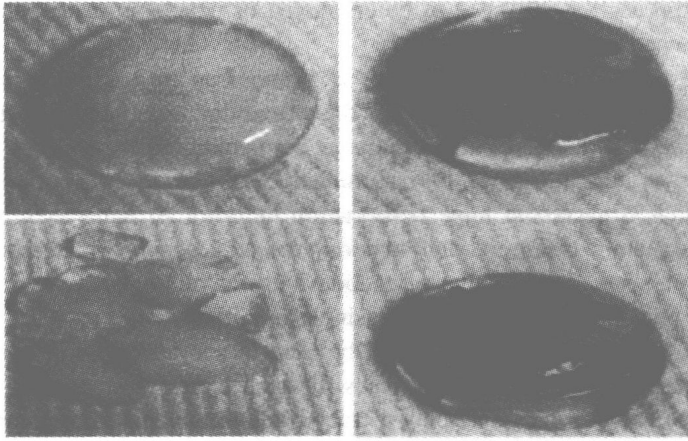


Figure 1.1 Left: brittle fracture of non-reinforced ice after drop test. Right: unbroken reinforced ice after drop test. Images are courtesy of Prof. Yip-Wah Chung, Northwestern University.

the statistical nature of defects and uncertainty analysis in processing and modeling in order to be considered complete.

A simple example of the necessity to account for microstructure in material modeling is shown in Figure 1.1. In the first case, a simple block of ice is dropped from a certain height onto the ground; as can be seen, the ice fractures into multiple pieces, reflecting its brittle nature. In the second case, the ice has been reinforced by strips of newspaper. Upon being dropped from the same height, the block of ice stays intact, and does not break. Clearly, the added microstructural effects in the form of the newspaper dramatically enhanced the strength of the ice.

A real-life example of the strengthening properties of material microstructure is given in Figure 1.2. There, the various complicated deformation mechanisms that exist at different material length scales in a typical high-strength steel is illustrated in a schematic. As can be seen, the overall structural response of the ship is governed by the interactions between the inclusions, second phase particles and defects that occur in the steel at different length scales. The TiN primary inclusions are typically micron sized, and govern fracture toughness due to decohesion and debonding. The secondary TiC inclusions are typically nanometer sized, and provide strengthening after yield by controlling the interfacial separation. Thus, the resultant mechanical properties of the steel are a competition between strength and toughness, with the inclusions at different scales dominating at each end of the spectrum.

We emphasize that while the mechanical response of the steel can be modeled hierarchically, that is, by using average properties from smaller length scales to control the macroscopic response, it is currently impossible to concurrently model all the way from atomistics to continuum without leaving out the crucial intermediate, mesoscopic length scales. Modeling from atoms to continuum represents a grand challenge in material design